

Final Finish Conditioners

Are non-plated tooling holes and background plating problems for you?

RONAMERSE™ SMT Hole Conditioner

RONAMERSE™ SMT Hole Conditioner is designed to poison the catalytic effect of residual palladium from metallization processing, so ensuring that non-plated holes remain free of unwanted metal deposits after the subsequent RONAMERSE™ SMT process sequence.

Benefits

- Fully analyzable
- Easy to operate and control



without use of hole conditioner



With hole conditioner

CONDITIONER BP

Conditioner BP works in conjunction with the catalyst to control the initiation of electroless nickel.

Benefits

- Eliminates background plating
- Ease of use operation
- Easy to control
- Operate in ambient temperature

